

#### Continental Device India Limited

An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company



#### NPN SILICON PLANAR EPITAXIAL TRANSISTORS

BC413, B, C BC414, B, C

TO-92 Plastic Package

### ABSOLUTE MAXIMUM RATINGS (T<sub>a</sub>=25°C)

DESCRIPTION	SYMBOL	BC413	BC414	UNITS	
Collector Emitter Voltage	V <sub>CEO</sub>	30	45	V	
Collector Base Voltage	$V_{CBO}$	45	50	V	
Emitter Base Voltage	$V_{EBO}$	5.0			
Collector Current Continuous	I <sub>C</sub>	100			
Power Dissipation at T <sub>a</sub> =25°C	$P_{D}$	350			
Derate Above 25ºC		2.8			
Power Dissipation at T <sub>c</sub> =25°C	$P_{D}$	1.0			
Derate Above 25°C		8.0			
Operating and Storage Junction Temperature Range	$T_J$ , $T_{stg}$	- 55 to +150			

### THERMAL RESISTANCE

Junction to Case	R <sub>th (j-c)</sub>	125	ºC/W
Junction to Ambient in free air	R <sub>th (j-a)</sub>	357	<sup>o</sup> C/W

### **ELECTRICAL CHARACTERISTICS (T<sub>a</sub>=25°C unless specified otherwise)**

DESCRIPTION	SYMBOL	TEST CONDITION	BC413	BC413 BC414	
Collector Emitter Voltage	$V_{CEO}$	$I_C=1 \text{mA}, I_B=0$	>30 >45		V
Collector Base Voltage	$V_{CBO}$	$I_{C}=10\mu A, I_{E}=0$	>45	>50	V
Emitter Base Voltage	$V_{EBO}$	$I_{E}=10\mu A, I_{C}=0$	>5	5.0	V
Collector Cut Off Current	I <sub>CBO</sub>	$V_{CB}=30V$ , $I_{E}=0$	<	15	nA
		$V_{CB}=30V$ , $I_{E}=0$ , $T_{a}=+125$ $^{\circ}C$	<5	5.0	μΑ
Emitter Cut Off Voltage	I <sub>EBO</sub>	$V_{EB}=4V, I_{C}=0,$	<	15	nA
DC Current Gain	h <sub>FE</sub>	I <sub>C</sub> =10μA, V <sub>CE</sub> =5V, <b>BC413/414</b>	>1	00	
		$I_C=2mA, V_{CE}=5V$			
		BC413B/414C	180 - 460		
		BC413C/414C	380 - 800		
		BC413/414	180 -	- 800	
<b>Collector Emitter Saturation Voltage</b>	V <sub>CE (sat)</sub>	$I_C=10mA$ , $I_B=0.5mA$	<0.25		V
		$I_C=10$ mA, $I_B=$ see *	<0.6		V
		$^{**}I_{C}=100$ mA, $I_{B}=5$ mA	<(	0.6	V
Base Emitter Saturation Voltage	V <sub>BE (sat)</sub>	$^{**}I_{C}=100$ mA, $I_{B}=5$ mA	TYP1.1		V
Base Emitter On Voltage	V <sub>BE (on)</sub>	$I_{C}=10\mu A, V_{CE}=5V$	TYP0.52		V
		$I_C=100\mu A,\ V_{CE}=5V$	TYP	0.55	V
		$I_C=2mA$ , $V_{CE}=5V$	0.55	- 0.75	V

<sup>\*</sup>I<sub>B</sub> is Value for Which I<sub>C</sub>=11mA at V<sub>CE</sub>=1V

<sup>\*\*</sup>Pulse test:- Pulse Width =300µs, Duty Cycle 2%

# NPN SILICON PLANAR EPITAXIAL TRANSISTORS



BC413, B, C BC414, B, C

TO-92 Plastic Package

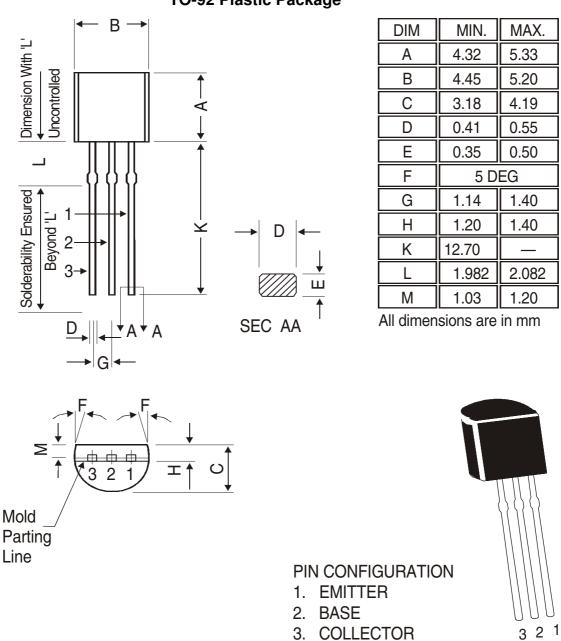
# ELECTRICAL CHARACTERISTICS (T<sub>a</sub>=25°C unless specified otherwise)

#### **SMALL SIGNAL CHARACTERISTICS**

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Transistors Frequency	f <sub>T</sub>	$I_C=10$ mA, $V_{CE}=5$ V, $f=100$ MHz		250		MHz
Collector Base Capacitance	$C_cbo$	$V_{CE}=10V$ , $f=1MHz$		2.5		рF
Noise Figure	N <sub>F</sub>	$I_C$ =200 $\mu$ A, $V_{CE}$ =5 $V$ , $R_S$ =2 $K\Omega$ , $f$ =30 $H_Z$ -15 $k$ $H_Z$			4.0	dB

TO-92 Plastic Package





The TO-92 Package, Tape and Ammo Pack drawings are correct as on the date of issue/revision of this Data Sheet.

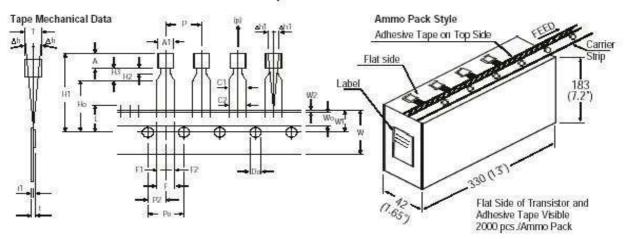
The currently valid dimensions and information, may please be confirmed from the TO-92 Drawing in the Packages and Packing Section of the Product Catalogue.

#### **Packing Details**

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size Qty S		Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

TO-92 Plastic Package

#### TO-92 Tape and Ammo Pack



#### All dimensions are in mm

		SPECIFICATION						
ITEM	SYMBOL	MIN.	NOM.	MAX.	TOL.	1		
BODY WIDTH	A1	4.45		5.20		NOTES		
BODY HEIGHT	A	4.32		5.33		Maximum alignment deviation between		
BODY THICKNESS	T	3.18		4.19		leads will not to be greater than 0.2mm		
PITCH OF COMPONENT	P		12.7		$\pm 1.0$	Maximum non-cumulative variation		
*1FEED HOLE PITCH	Po		12.7		$\pm 0.3$	between tape feed holes shall not		
*2 FEED HOLE CENTRE TO	60000		Acceptation (Control			exceed 1 mm in 20 pitches.		
COMPONENT CENTRE	P2		6.35		± 0.4	3. Holddown tape will not exceed beyond		
DISTANCE BETWEEN OUTER LEADS	E		5.08		+ 0.6	the edge(s) of carrier tape and there shall be no exposure of adhesive.		
*3 COMPONENT ALIGNMENT SIDE VIEW	Δh		0	1.0		4. There will be no more than three (3)		
*4 COMPONENT ALIGNMENT FRONT VIEW	Δh1		0	1.3		consecutive missing components in a		
TAPE WIDTH	w		18	10000	± 0.5	tape.		
HOLD-DOWN TAPE WIDTH	Wo		6		± 0.2	<ol><li>A tape trailer, having at least three feed</li></ol>		
HOLE POSITION	W1		9		+ 0.7	holes are provided after the last component in a tape.		
HOLD-DOWN TAPE POSITION	W2	0.0		0.7	905856	6. Splices should not interfere with the		
LEAD WIRE CLINCH HEIGHT	Ho	54525860	16	11.088850	± 0.5	sprocket feed holes.		
COMPONENT HEIGHT	Н1		SES	24.0	75.000			
LENGTH OF SNIPPED LEADS	S E			11.0				
FEED HOLE DIAMETER	Do		4		± 0.2	REMARKS		
*5 TOTAL TAPE THICKNESS	t		100	1.2				
LEAD - TO - LEAD DISTANCE	F1, F2	2.40		2.70		*1 Cumulative pitch error 1.0 mm/20 pitch		
STAND OFF	H2	0.45		1.45	- 0.1	*2 To be measured at bottom of clinch		
CLINCH HEIGHT	H3			3.0		*3 At top of body		
LEAD PARALLELISM	[C1 - C2]			0.22		*4 At top of body		
PULL - OUT FORCE	(p)	6N		H81/5962		*5 t1 0.3 - 0.6 mm		

#### **Component Disposal Instructions**

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

**Customer Notes** 

BC413, B, C BC414. B. C

TO-92 **Plastic Package** 

## **Disclaimer**

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



CDIL is a registered Trademark of Continental Device India Limited C-120 Naraina Industrial Area, New Delhi 110 028, India. Telephone + 91-11-2579 6150, 4141 1112 Fax + 91-11-2579 5290, 4141 1119 email@cdil.com www.cdilsemi.com